Effective March 2023 Supersedes December 2021

# MFBA2V2012 Automotive multilayer chip ferrite bead



## **Product features**

- AEC-Q200
- Multilayer monolithic construction yields
  high reliability
- 0805 (2012 metric) surface mount package
- Ultra-low direct current resistance (DCR)
- Impedance range: 30 ohms to 1000 ohms
- · Moisture sensitivity level (MSL): 1

## Applications

- Body electronics (keyless entry, ECU, antennas)
- Advanced driver assistance systems (ADAS)
- Infotainment and cluster electronics
- Safety electronics systems
- WLAN, WiFi, Bluetooth
- Portable medical devices
- Inventory management equipment
- Displays/monitors
- IoT, remote monitoring
- Testing equipment
- Automation equipment
- Sensors

#### Environmental compliance and general specifications

- Operating temperature range: -55 °C to +150 °C (ambient plus self-temperature rise)
- Storage temperature (component): -55 °C to +150 °C
- Solder reflow temperature: J-STD-020 (latest revision) compliant





Schematic

## **Product specifications**

Part number <sup>2</sup>	Impedance (Ω) 100 MHz, ±25%, @ +25°C	DCR (Ω) maximum @ +25 °C	Rated current <sup>1</sup> (mA) maximum
MFBA2V2012-300-R	30	0.04	3000
MFBA2V2012-800-R	80	0.04	3000
MFBA2V2012-121-R	120	0.1	2000
MFBA2V2012-151-R	150	0.1	2000
MFBA2V2012-221-R	220	0.1	2000
MFBA2V2012-301-R	300	0.2	1000
MFBA2V2012-471-R	470	0.2	1000
MFBA2V2012-601-R	600	0.2	1000
MFBA2V2012-102-R	1000	0.15	1500
MFBA2V2012P-700-R	70	0.009	6000
MFBA2V2012P-111-R	110	0.013	5000
MFBA2V2012P-181-R	180	0.02	4000
MFBA2V2012P-331-R	330	0.04	2800
MFBA2V2012P-471-R	470	0.05	2500
MFBA2V2012P-601-R	600	0.06	2300

1. Rated current: DC current rating for an approximate self-temperature rise of 40 °C or less.

 Part number definition: MFBA2V2012-xxx-R or MFBA2V2012P-xxx-R MFBA2V2012 = Product code and size MFBA2V2012P = Product code and size xxx = Impedance value in Ω, last character equals number of zeros -R suffix = RoHS compliant

## Mechanical parameters (mm)



**Recommended pad layout** 

Part marking: No marking

All soldering surfaces to be coplanar within 0.1 millimeters

Tolerances are  $\pm 0.1$  millimeters unless stated otherwise Pad layout dimensions are reference only

Traces or vias underneath the inductor is not recommended

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## Packaging information (mm)

Drawing not to scale

Supplied in tape and reel packaging, 4000 parts per 7" diameter reel (EIA-481 compliant)



Во	$2.10 \pm 0.05$	
Ao	$1.30 \pm 0.05$	
Ко	$0.95 \pm 0.05$	
Р	4.0 ± 0.10	
t	0.95 ± 0.05	

## Performance curves

Z= impedance, R= resistance, X= reactance



0

1

10

100

Frequency(MHz)

1000

10000

10

100

Frequency(MHz)

1000

10000

0

1

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## **Performance curves**

Z= impedance, R= resistance, X= reactance













Technical Data ELX1132 Effective March 2023

## **Performance curves**

Z= impedance, R= resistance, X= reactance







**Derating curve** 



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## Solder reflow profile



#### Table 1 - Standard SnPb solder (T<sub>c</sub>) To -5°C Table 2 - Lead (Pb) free solder (Table 2)

Table 2 - Leau (Eb) Thee Soluer (TC)				
Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000	
<1.6 mm	260 °C	260 °C	260 °C	
1.6 – 2.5 mm	260 °C	250 °C	245 °C	
>2.5 mm	250 °C	245 °C	245 °C	

#### **Reference J-STD-020**

Powering Business Worldwide

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T <sub>smin</sub> )	100 °C	150 °C
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Ramp up rate T <sub>L</sub> to T <sub>p</sub>	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (tL) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature $(T_c)$	20 seconds*	30 seconds*
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 $^{\ast}$  Tolerance for peak profile temperature (T\_p) is defined as a supplier minimum and a user maximum.

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